

Application Specific Discretes A.S.D.™

APPLICATIONS

Where transient overvoltage protection in ESD sensitive equipment is required, such as :

- COMPUTERS
- PRINTERS
- COMMUNICATION SYSTEMS
- GSM HANDSETS AND ACCESSORIES
- OTHER TELEPHONE SETS

FEATURES

- **.** 18 UNIDIRECTIONAL TRANSIL FUNCTIONS
- LOW LEAKAGE CURRENT: I_R max. < 2 μA
- 200 W PEAK PULSE POWER (8/20 μs)

DESCRITION

The ESDA6xxSx is a monolithic voltage suppressor designed to protect components which are connected to data and transmission lines against ESD.

It clamps the voltage just above the logic level supply for positive transients, and to a diode drop below ground for negative transients.

BENEFITS

High ESD protection level : up to 25 kV High integration Suitable for high density boards

COMPLIES WITH THE FOLLOWING STANDARDS :

IEC 1000-4-2 : level 4

MIL STD 883C-Method 3015-6 : class3 (human body model)

ESDA6V1S3 ESDA6V2S6

TRANSIL ARRAY FOR ESD PROTECTION



FUNCTIONAL DIAGRAM



ESDA6V1S3 / ESDA6V2S6

ABSOLUTE MAXIMUM RATINGS (Tamb = 25°C)

Symbol	Parameter	Value	Unit
V _{PP}	Electrostatic discharge MIL STD 883C - Method 3015-6	25	kV
P _{PP}	Peak pulse power (8/20μs)	200	W
T _{stg} T _j	Storage temperature range Maximum junction temperature	- 55 to + 150 150	°C ℃
TL	Maximum lead temperature for soldering during 10s	260	∘C

ELECTRICAL CHARACTERISTICS (Tamb = 25°C)

Symbol	Parameter				
V _{RM}	Stand-off voltage				
V _{BR}	Breakdown voltage				
V _{CL}	Clamping voltage				
I _{RM}	Leakage current				
IPP	Peak pulse current				
ατ	Voltage temperature coefficient				
С	Capacitance				
Rd	Dynamic resistance				
VF	Forward voltage drop				



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Types	v	BR @	I _R	I _{RM} @	V _{RM}	Rd	αΤ	С	V _F @	⊉l⊧
	min.	max.		max.		typ.	max.	typ.	max.	
	note1			note1		note 2	note 3	0V bias		
	V	V	mA	μA	V	Ω	10 ⁻⁴ /°C	pF	V	mA
ESDA6V1S3	6.1	7.2	1	2	5.25	0.5	6	120	1.25	200
ESDA6V2S6	6.2	7.2	1	2	5.25	0.5	6	100	1.25	200

Note 1 : Between any I/O pin and Ground Note 2 : Square pulse, IPP = 25A for ESDA6V1S3 and IPP = 15A for ESDA6V2S6 , t_p = 2.5 μ s Note 3 : Δ VBR = α T * [Tamb-25] * VBR(25°C)

CALCULATION OF THE CLAMPING VOLTAGE

USE OF THE DYNAMIC RESISTANCE

The ESDA family has been designed to clamp fast spikes like ESD. Generally the PCB designers need to calculate easily the clamping voltage V_{CL} . This is why we give the dynamic resistance in addition to the classical parameters. The voltage across the protection cell can be calculated with the following formula:

 $V_{CL} = V_{BR} + Rd I_{PP}$

Where lpp is the peak current through the ESDA cell.

DYNAMIC RESISTANCE MEASUREMENT

The short duration of the ESD has led us to prefer a more adapted test wave, as below defined, to the classical $8/20\mu s$ and $10/1000\mu s$ surges.



2.5µs duration measurement wave.

As the value of the dynamic resistance remains stable for a surge duration lower than 20μ s, the 2.5 μ s rectangular surge is well adapted. In addition both rise and fall times are optimized to avoid any parasitic phenomenon during the measurement of Rd.

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ESDA6V1S3 / ESDA6V2S6

Fig. 1 : Peak power dissipation versus initial junction temperature.



Fig. 2 : Peak pulse power versus exponential pulse duration (Tj initial = 25 °C).



Fig. 3 : Clamping voltage versus peak pulse current (Tj initial = 25 °C). Rectangular waveform tp = $2.5 \mu s$.



Fig. 5 : Relative variation of leakage current versus junction temperature (typical values).



Fig. 4 : Capacitance versus reverse applied voltage (typical values).



Fig. 6 : Peak forward voltage drop versus peak forward current (typical values).



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APPLICATION EXAMPLE : 1 - Protection of logic-level signals. (ex : centronics junction)



2 - Protection of symmetrical signals. Note : Capacitance value between any I/O pin and Ground is divided by 2.



Implementing its ASDTM technology, STMicroelectronics has developed a monolithic TRANSIL diode array, which is a reliable protection against electrostatic overloads for computer I/O ports, modems, GSM handsets and accessories or other similar systems with data outputs. The ESDAxxSx integrates 18 TRANSIL diodes in a compact package that can be easily mounted close to the circuitry to be protected, eliminating the assembly costs associated with the

use of discrete diodes, and also increasing system reliability.

Each TRANSIL has a breakdown voltage between 6.2V (minimum) and 7.2V (maximum). When the input voltage is lower than the breakdown voltage, the diodes present a high impedance to ground. For short overvoltage pulses, the fast-acting diodes provide an almost instantaneous response, clamping the voltage to a safe level.

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ESDA6V1S3 / ESDA6V2S6

ORDER CODE



MARKING : Logo, date code

ТҮРЕ	MARKING		
ESDA6V1S3	E6V1S3		
ESDA6V2S6	ESDA6V2S6		

Packaging : Preferred packaging is tape and reel.

PACKAGE MECHANICAL DATA





		DIMENSIONS					
REF.	Mi	llimete	ers	Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	2.35		2.65	0.092		0.104	
A1	0.10		0.20	0.004		0.008	
В	0.33		0.51	0.013		0.020	
С	0.23		0.32	0.009		0.013	
D	12.6		13.0	0.484		0.512	
E	7.40		7.60	0.291		0.299	
е		1.27			0.050		
Н	10.0		10.65	0.394		0.419	
h	0.25		0.75	0.010		0.029	
L	0.50		1.27	0.020		0.050	
К	8° (max)						

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Weight : 0.55g.

PACKAGE MECHANICAL DATA SSOP20 (Plastic)



	DIMENSIONS						
REF.	Μ	illimete	rs	Inches			
	Min.	/lin. Typ.		Min.	Тур.	Max.	
Α			2.00			0.079	
A1			0.25			0.010	
A2	1.51		2.00	0.059		0.079	
b	0.25	0.30	0.35	0.010	0.012	0.014	
с	0.10		0.35	0.004		0.014	
D	7.05		8.05	0.278		0.317	
E	7.60		8.70	0.299		0.343	
E1	5.02	6.10	6.22	0.198	0.240	0.245	
е		0.65			0.026		
k	0°		10°	0°		10°	
L	0.25	0.50	0.80	0.010	0.020	0.031	

Weight : 0.18g.

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